

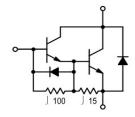
An IATF 16949, ISO9001 and ISO 14001 Certified Company

NPN Silicon Power DarligtonTransistor

with Base-Emitter Speedup Diode

60 AMPERE, 200 AND 250 VOLTS, 250 WATTS









MJ10020 MJ10021

TO-3 Metal Can Package RoHS compliant

GENERAL DESCRIPTION

The MJ10020 and MJ10021 Darlington transistors are designed for high–voltage, high–speed, power switching in inductive circuits where fall time is critical. They are particularly suited for line operated switchmode applications

FEATURES:

1. Fast Turn-Off Times

150 ns Inductive Fall Time at 25° C (Typ) 750 ns Inductive Storage Time at 25 °C (Typ)

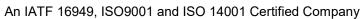
- 2. Operating Temperature Range -65 to +200° C
- 3. 100° C Performance Specified for:

Reversed Biased SOA with Inductive Loads Switching Times with Inductive Loads Saturation Voltages

APPLICATIONS:

- 1. AC and DC Motor Controls
- 2. Switching Regulators
- 3. Solenoid and Relay Drivers









ABSOLUTE MAXIMUM RATING (T_A=25 ° C unless otherwise specified)

Rating	Symbol	MJ10020	MJ10021	Unit
Collector–Emitter Voltage	VCEO	200	250	Vdc
Collector–Emitter Voltage	VCEV	300	350	Vdc
Emitter Base Voltage	V _{EB}	8.0		Vdc
Collector Current — Continuous — Peak (1)	I _C	60 100		Adc
Base Current — Continuous — Peak (1)	I _B	20 30		Adc
Total Power Dissipation @ T _C = 25°C @ T _C = 100°C Derate above 25°C	PD	250 143 1.43		Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R JC	0.7	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8 from Case for 5 Seconds	ΤL	275	°C

⁽¹⁾ Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.



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ELECTRICAL CHARACTERISTICS (T_A=25 ° C unless otherwise specified)

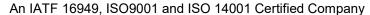
	Symbol	Min	Тур	Max	Unit		
OFF CHARACTERIST	ics						
Collector–Emitter Sus (I _C = 100 mA, I _B =	VCEO(sus)	200 250	_	_	Vdc		
Collector Cutoff Curre (V _{CEV} = Rated Va (V _{CEV} = Rated Va	ICEV	_	_	0.25 5.0	mAdc		
Collector Cutoff Curre (V _{CE} = Rated V _{CE}	ent _{EV} , R _{BE} = 50 , T _C = 100°C)		ICER	_	-	5.0	mAdc
Emitter Cutoff Curren (V _{EB} = 2.0 V, I _C =			I _{EBO}	§ <u>9 </u>	_	175	mAdc
SECOND BREAKDOV	VN						
Second Breakdown C	Collector Current with base forward biased		I _{S/b}		See Fi	gure 13	
Clamped Inductive S	OA with Base Reverse Biased		RBSOA		See Fi	gure 14	
ON CHARACTERISTIC	CS (1)				ž.		
DC Current Gain (I _C = 15 Adc, V _{CE}	= 5.0 V)		hFE	75		1000	
Collector–Emitter Saturation Voltage (I _C = 30 Adc, I _B = 1.2 Adc) (I _C = 60 Adc, I _B = 4.0 Adc) (I _C = 30 Adc, I _B = 1.2 Adc, T _C = 100°C)			VCE(sat)	=		2.2 4.0 2.4	Vdc
Base–Emitter Saturation Voltage (I _C = 30 Adc, I _B = 1.2 Adc) (I _C = 30 Adc, I _B = 1.2 Adc, T _C = 100°C)			V _{BE} (sat)	=	=	3.0 3.5	Vdc
Diode Forward Voltage (I _F = 30 Adc)			Vf	_	2.5	5.0	Vdc
DYNAMIC CHARACTE	ERISTICS						***
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f _{test} = 1.0 kHz)			C _{ob}	175	-	700	pF
SWITCHING CHARAC	TERISTICS						
Resistive Load (Tab	le 1)				***		160
Delay Time			t _d	_	0.02	0.2	s
Rise Time	(V _{CC} = 175 Vdc, I _C = 30 A,		t _r	_	0.30	1.0	s
Storage Time	$I_{B1} = Adc, V_{BE(off)} = 5.0 \text{ V}, t_p = 25$ Duty Cycle $\leq 2.0\%$).	5	t _S	_	1.0	3.5	s
Fall Time			t _f	_	0.07	0.5	s
Inductive Load, Clar	mped (Table 1)					•	•
Storage Time	I _{CM} = 30 A(pk), V _{CEM} = 200 V, I _{B1} = 1.2 A,		t _{sv}	-	1.2	3.5	s
Crossover Time	V _{BE(off)} = 5 V, T _C = 100 °C)	t _C	_	0.45	2.0	s	
Storage Time			t _{sv}	_	0.75	_	s
Crossover Time	(I _{CM} = 30 A(pk), V _{CEM} = 200 V, I _{B1} = 1.2 A,		t _c	_	0.25	_	s
Fall Time	$V_{BE(off)} = 5 \text{ V}, T_{C} = 25 \text{ C}$	1	t _{fi}	_	0.15	_	s

(1) Pulse Test: PW = 300 s, Duty Cycle ≤ 2%.

MJ10020_21

Rev0_04052020EM









TYPICAL CHARACTERISTIC CIRVES

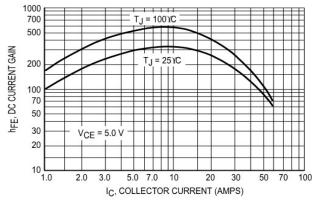


Figure 1. DC Current Gain

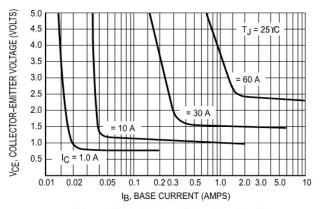


Figure 2. Collector Saturation Region

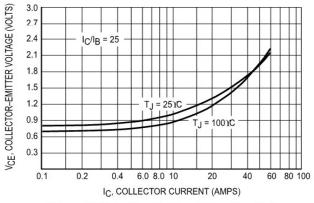


Figure 3. Collector-Emitter Saturation Voltage

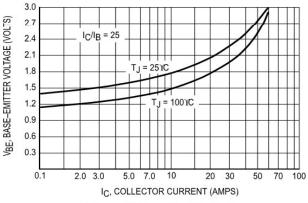


Figure 4. Base-Emitter Voltage

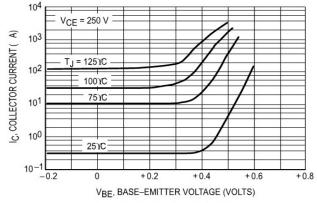


Figure 5. Collector Cutoff Region

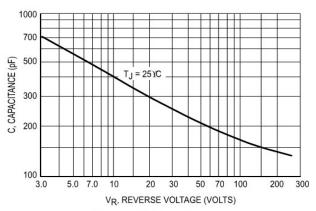


Figure 6. Output Capacitance



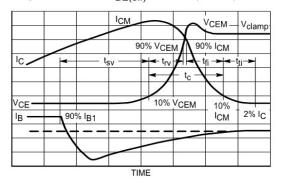


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Table 1. Test Conditions for Dynamic Performance

	V _{CEO(sus)}	RBSOA AND INDUCTIVE SWITCHING	RESISTIVE SWITCHING	
INPUT	20 5 V 1 0 1 2 2 PW Varied to Attain I _C = 100 mA	INDUCTIVE TEST CIRCUIT TUT IN4937 SEE ABOVE FOR DETAILED CONDITIONS 2 RCOIL OCIVALENT Volamp RCOIL Volamp VCC	TURN-ON TIME O 1 IB1 adjusted to obtain the forced hFE desired TURN-OFF TIME Use inductive switching driver as the input to the resistive test circuit.	
CIRCUIT	L _{coil} = 10 mH, V _{CC} = 10 V R _{coil} = 0.7 V _{clamp} = V _{CEO} (sus)	R _{coil} = 0.7		
TEST CIRCUITS	lc	OUTPUT WAVEFORMS $t_1 \text{ Adjusted to } Obtain \ I_C$ $t_1 \ $	RESISTIVE TEST CIRCUIT 1 O R. R. R. R. VCC	

^{*} Adjust –V such that VBE(off) = 5 V except as required for RBSOA (Figure 14).



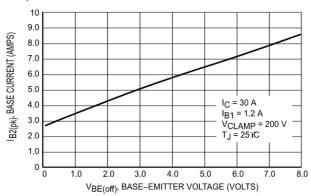


Figure 7. Inductive Switching Measurements

Figure 8. Typical Peak Reverse Base Current

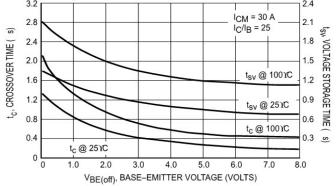
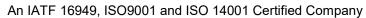


Figure 9. Typical Inductive Switching Times









RESISTIVE SWITCHING

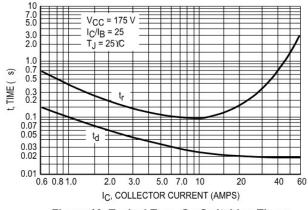


Figure 10. Typical Turn-On Switching Times

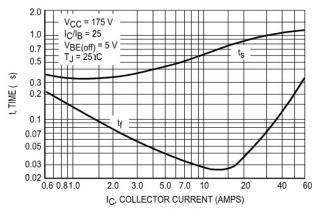


Figure 11. Typical Turn-Off Switching Times

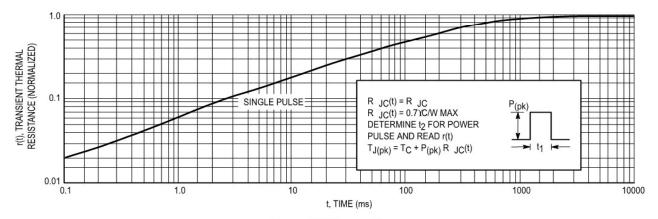
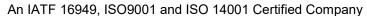


Figure 12. Thermal Response









The Safe Operating Area figures shown in Figures 13 and are specified for these devices under the test conditions shown.

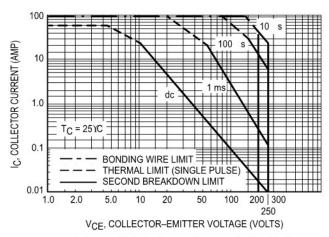


Figure 13. Maximum Forward Bias Safe Operating Area

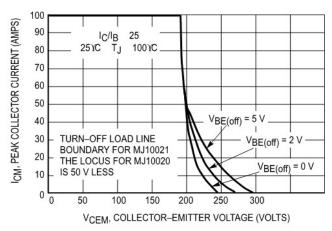


Figure 14. Maximum RBSOA, Reverse Bias Safe Operating Area

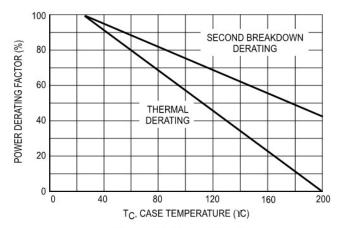
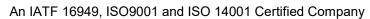


Figure 15. Power Derating

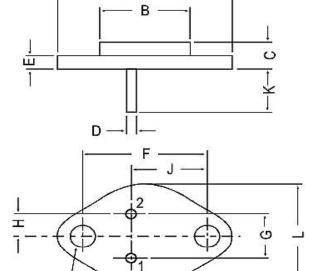






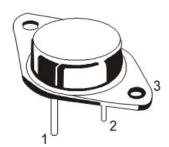


Package Details



All dimensions in mm.

DIM	MIN.	MAX.
Α		39.37
В	_	22.22
С	6.35	8.50
D	0.96	1.09
E		1.77
F	29.90	30.40
G	10.69	11.18
Н	5.20	5.72
J	16.64	17.15
K	11.15	12.25
L	L —	
М	3.84	4.19



PIN CONFIGURATION

- 1. BASE
- 2. EMITTER
- 3. COLLECTOR

Packing Detail

М

	PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
9		Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
	TO-3	100 pcs/pkt	1.3 kg/100 pcs	12.5" x 8" x 1.8"	0.1K	17" x 11.5" x 21"	2K	27.5 kgs



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Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- · Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- · Air should be clean.
- · Avoid harmful gas or dust.
- · Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- · Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- Avoid rapid change of temperature.
- · Avoid condensation.
- · Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level					
Level	Time	Condition			
1	Unlimited	≤30 °C / 85% RH			
2	1 Year	≤30 °C / 60% RH			
2a	4 Weeks	≤30 °C / 60% RH			
3	168 Hours	≤30 °C / 60% RH			
4	72 Hours	≤30 °C / 60% RH			
5	48 Hours	≤30 °C / 60% RH			
5a	24 Hours	≤30 °C / 60% RH			
6	Time on Label(TOL)	≤30 °C / 60% RH			







Customer Notes

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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BCV47E6327HTSA1 BSP61H6327XTSA1 BU941ZPFI NTE2350 NTE245 NTE246 NTE2649 NTE46 NTE98 ULN2003ADR2G
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